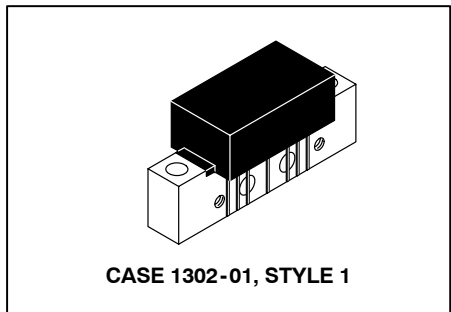
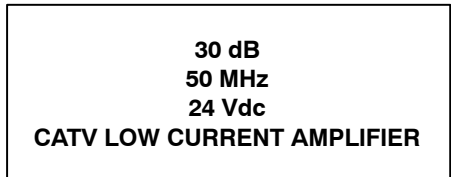


Low Distortion Wideband Reverse Amplifier Module

Designed specifically for broadband applications requiring low distortion characteristics. Specified for use as return amplifiers for low-split 2-way cable TV systems. Features all gold metallization system.

- Guaranteed Broadband Power Gain
- Guaranteed Broadband Noise Figure
- Superior Gain, Return Loss and DC Current Stability with Temperature
- All Gold Metallization
- Circuit Design Optimized for Good RF Stability Under High VSWR Load Conditions
- Transformers Designed to Ensure Good Low Frequency Gain Stability versus Temperature



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Table 1. Maximum Ratings*

Parameter	Symbol	Value	Unit
DC Supply Voltage	V _{CC}	+28	Vdc
RF Input Voltage (Single Tone)	V _{IN}	+70	dBmV
Operating Case Temperature Range	T _C	- 20 to +100	°C
Storage Temperature Range	T _{stg}	- 40 to +100	°C

Table 2. Electrical Characteristics (V_{CC} = 24 Vdc, T_C = 30°C, 75 ohm system, unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Bandwidth All	BW	5.0	50	MHz
Power Gain (f = 5.0 MHz)	G _p	29.2	30.8	dB
Slope (f = 50-65 MHz)	S	-0.2	—	dB
Return Loss (@ f = 5.0-50 MHz) (@ f = 65 MHz)	RL	18 16	— —	dB
Second Order Distortion (V _{out} = +50 dBmV/ch)	IMD	—	- 70	dBc
Cross Modulation (V _{out} = +50 dBmV/ch)	XMD ₄	—	- 57	dBc
Triple Beat Distortion (V _{out} = +50 dBmV/ch)	TB ₃	—	- 66	dBc
Noise Figure (f = 50 MHz)	NF	—	4.5	dB
DC Current	I _{DC}	100	135	mA

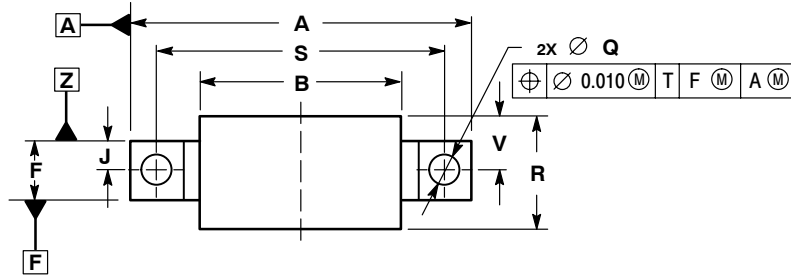


NOTES

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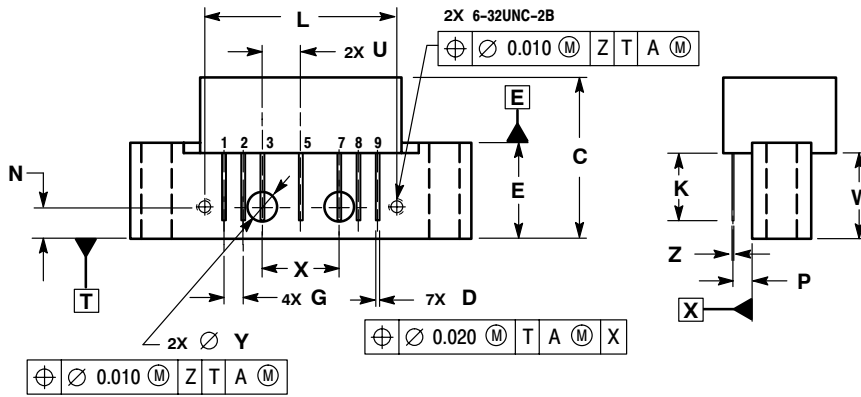
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PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONS ARE IN INCHES.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	1.775	---	45.085
B	---	1.085	---	27.559
C	---	0.840	---	21.336
D	0.015	0.021	0.381	0.533
E	0.465	0.510	11.811	12.954
F	0.300	0.325	7.62	8.255
G	0.100 BSC		2.540 BSC	
J	0.156 BSC		3.962 BSC	
K	0.315	0.355	8.001	9.017
L	1.000 BSC		25.400 BSC	
N	0.165 BSC		4.191 BSC	
P	0.100 BSC		2.540 BSC	
Q	0.148	0.168	3.759	4.267
R	---	0.600	---	15.24
S	1.500 BSC		38.100 BSC	
U	0.200 BSC		5.080 BSC	
V	---	0.250	---	6.350
W	0.435	---	11.049	---
X	0.400 BSC		10.160 BSC	
Y	0.152	0.163	3.861	4.140
Z	0.009	0.011	0.229	0.279



CASE 1302-01
 ISSUE B

- STYLE 1:
 PIN 1. RF INPUT
 2. GROUND
 3. GROUND
 4. DELETED
 5. VDC
 6. DELETED
 7. GROUND
 8. GROUND
 9. RF OUTPUT

How to Reach Us:

Home Page:
www.freescale.com

E-mail:
support@freescale.com

USA/Europe or Locations Not Listed:
Freescale Semiconductor
Technical Information Center, CH370
1300 N. Alma School Road
Chandler, Arizona 85224
+1-800-521-6274 or +1-480-768-2130
support@freescale.com

Europe, Middle East, and Africa:
Freescale Halbleiter Deutschland GmbH
Technical Information Center
Schatzbogen 7
81829 Muenchen, Germany
+44 1296 380 456 (English)
+46 8 52200080 (English)
+49 89 92103 559 (German)
+33 1 69 35 48 48 (French)
support@freescale.com

Japan:
Freescale Semiconductor Japan Ltd.
Headquarters
ARCO Tower 15F
1-8-1, Shimo-Meguro, Meguro-ku,
Tokyo 153-0064
Japan
0120 191014 or +81 3 5437 9125
support.japan@freescale.com

Asia/Pacific:
Freescale Semiconductor Hong Kong Ltd.
Technical Information Center
2 Dai King Street
Tai Po Industrial Estate
Tai Po, N.T., Hong Kong
+800 2666 8080
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